



SDA006

DATA BUS TRANSIENT SUPPRESSOR/3-PHASE FULL WAVE BRIDGE RECTIFIER

Features

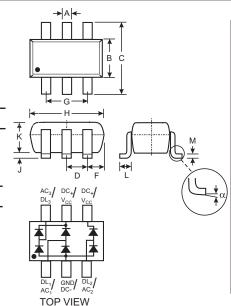
- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For 3-Phase Full Wave Bridge Rectification, or 3 Dataline Rail Clamp
- Lead Free By Design/RoHS Compliant (Note 3)
- "Green" Device (Note 4)

IEC Compatibility (Note 5)

- 61000-4-2 (ESD) Air-10kV Contact-8kV
- 61000-4-5 (Surge) 8x20μs, 14.5 Amperes

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 4)
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208
- Ordering Information, See Page 3
- Marking: JAC (See Page 3)
- Weight: 0.006 grams (approximate)



SOT-363								
Dim	Min	Max						
Α	0.10	0.30						
В	1.15	1.35						
С	2.00 2.20							
D	0.65 N	ominal						
E	0.30	0.40						
G	1.80	2.20						
Н	1.80	2.20						
J								
K	0.90 1.00							
L	0.25	0.40						
M	0.10	0.25						
α	0°	8°						
All Dimensions in mm								

Maximum Ratings @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V		
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	V_{RWM} 75			
RMS Reverse Voltage	V _{R(RMS)}	53	V		
Forward Continuous Current (Note 1)	I _{FM}	215	mA		
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	2.0 1.0 0.5	А		
Clamping Voltage (Note 6) @ lpp = 14.5A 8x20µs Waveform	Vc	16	V		
Power Dissipation (Note 1)	Pd	200	mW		
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ heta JA}$	625	°C/W		
Power Dissipation (Note 2)	P _d	300	mW		
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{ heta JA}$	417	°C/W		
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	°C		

Notes:

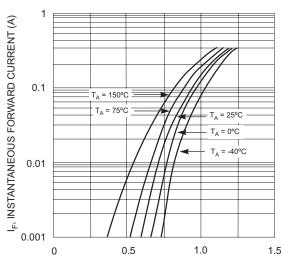
- 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Device mounted on Alumina PCB, 0.4 inch x 0.3 inch x 0.024 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 3. No purposefully added lead.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 5. Tested with V_{CC} connected to Ground to simulate appropriate V_{CC} decoupling to Ground.
- 6. Reference to V_{CC} or Ground.



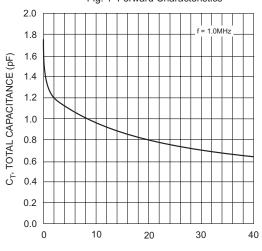
Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	75	_	_	V	$I_R = 2.5 \mu A$
Forward Voltage (Note 7)	V _F	_	_	0.715 0.855 1.0 1.25	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 7)		_	_	2.5 50 30 25	μΑ μΑ μΑ nA	$\label{eq:VR} \begin{array}{l} V_R = 75V \\ V_R = 75V, \ T_j = 150^{\circ}C \\ V_R = 25V, \ T_j = 150^{\circ}C \\ V_R = 20V \end{array}$
Junction Capacitance (per element)	CJ	_	_	2.0	pF	$V_R = 0V$, $f = 1.0MHz$
Capacitance, Between I/O Lines (I/O1 & I/O2)	C _{LL}	_	35	_	pF	$V_R = 0V$, $f = 1.0MHz$
Capacitance, Between I/O Line and Ground	C _{LG}	_	11	_	pF	V _R = 0V, f = 1.0MHz
Reverse Recovery Time	t _{rr}	_	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

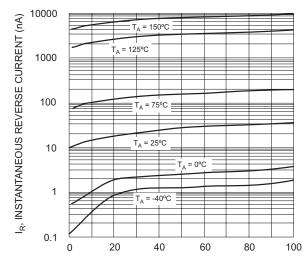
Notes: 7. Short duration test pulse used to minimize self-heating effect.



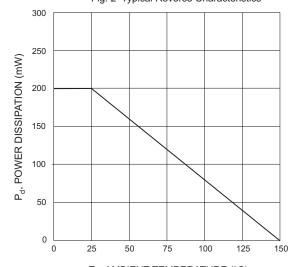
V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 1 Forward Characteristics



V_R, REVERSE VOLTAGE (V)
Fig. 3 Typical Junction Capacitance Per Element vs. Reverse Voltage



V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics



T_A, AMBIENT TEMPERATURE (°C) Fig. 4 Power Derating Curve

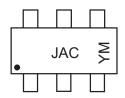


Ordering Information (Note 8)

Device	Packaging	Shipping			
SDA006-7	SOT-363	3000/Tape & Reel			

Notes: 8. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



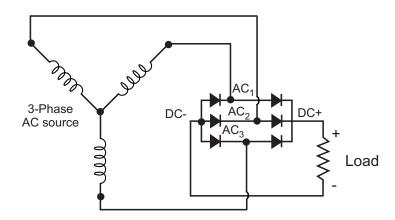
JAC = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

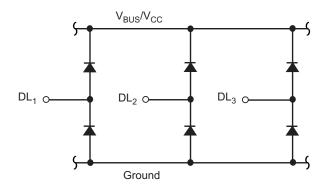
Year					2004	20	05	2006	200	07	2008		2009	
Code				R S		T U		J	V W		W			
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	N	lov	Dec	
Code	1	2	3	4	5	6	7	8	9	0		N	D	

Typical Applications

Three Phase, Full-Wave Bridge Rectifier



Data Line Bus Transient Suppressor





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